L Number	Hits	Search Text	DB	Time stamp	
- Number	10	(("6445640") or ("6438024") or ("6430251")	USPAT;	2003/01/04 11	1:56
	20	or ("6375135") or ("6265920") or	US-PGPUB		
		("6387237") or ("6429722") or ("6462604")			
		or ("6476663") or ("6392443")).PN.	USPAT	2003/01/02 18	2.20
-	0 : 5	6476663.URPN. ("4441023" "5345055" "6040668"	USPAT	2003/01/02 18	
_	5	"6121615" "6308519").PN.	001111	2003,01,02	
_	212	sun and sensor and register and clock and	USPAT;	2003/01/02 18	3:33
		interface and calibration	US-PGPUB		
-	0	sun and sensor and register and clock and	USOCR	2003/01/02 18	3:34
		interface and calibration	псраш.	2003/01/04 12	2.20
-	29	(therm\$ adj sensor same integrated adj circuit).clm.	USPAT; US-PGPUB	2003/01/04 12	2.20
_	0	therm\$ adj sensor same integrated adj	EPO; JPO;	2003/01/04 11	1:58
1		circuit and register	DERWENT;		
			IBM_TDB		
- i	0	thermal adj sensor same integrated adj	EPO; JPO;	2003/01/04 12	2:32
		circuit and register	DERWENT; IBM TDB		
	18	(therm\$ adj sensor same integrated adj	USPAT;	2003/01/04 12	2:25
-		circuit).clm.	US-PGPUB		
-	11	((therm\$ adj sensor same integrated adj	USPAT;	2003/01/04 12	2:20
		circuit).clm.) not ((therm\$ adj sensor	US-PGPUB		
		same integrated adj circuit).clm.)	USPAT;	2003/01/04 12	2.26
-	1	(((therm\$ adj sensor same integrated adj circuit).clm.) not ((therm\$ adj sensor	USPAT; US-PGPUB	2003/01/04 12	2.20
		same integrated adj circuit).clm.)) and	00 10100		
		register			
i -	2	((therm\$ adj sensor same integrated adj	USPAT;	2003/01/04 12	2:30
		circuit).clm.) and register	US-PGPUB	2003/01/04 12	2.32
-	30	thermal adj sensor same integrated adj	EPO; JPO; DERWENT;	2003/01/04 12	2.32
		CIFCUIT	IBM TDB		
_	36	thermal adj sensor same register	EPO; JPO;	2003/01/04 12	2:33
			DERWENT;		
	0.5		IBM_TDB	2003/01/04 12	2.16
-	25	thermal adj sensor with register	EPO; JPO; DERWENT;	2003/01/04 12	2.40
			IBM TDB		
-	1	2002-326874.NRAN.	DERWENT	2003/01/04 12	
_	0	2001103986.URPN.	USPAT	2003/01/04 12	
-	0	Semiconductor adj device with programmable	USPAT;	2003/01/04 12	2:51
	1	adj thermal adj sensor Semiconductor adj device with programmable	US-PGPUB EPO; JPO;	2003/01/04 12	2:47
-	1	adj thermal adj sensor	DERWENT;	2000,01,01	
	-		IBM_TDB		
-	1	Semiconductor adj device same programmable	EPO; JPO;	2003/01/04 12	2:48
		adj thermal adj sensor	DERWENT;		
	0	Semiconductor adj device same programmable	IBM_TDB USPAT;	2003/01/04 12	2:48
-		adj thermal adj sensor	US-PGPUB	2000,01,01 1	
_	0	Semiconductor adj device and programmable	USPAT;	2003/01/04 12	2:48
		adi thermal adi sensor	US-PGPUB	0000/01/01	0 40
-	1	Semiconductor adj device and programmable	EPO; JPO;	2003/01/04 12	∠:49
	[adj thermal adj sensor	DERWENT; IBM TDB		
_	5	Semiconductor adj device same thermal adj	EPO; JPO;	2003/01/04 12	2:49
		sensor	DERWENT;		
			IBM_TDB	0000155155	
-	193	Semiconductor adj device and thermal adj	USPAT;	2003/01/04 13	2:51
	37	sensor	US-PGPUB USPAT;	2003/01/04 1:	2:51
-	37	(Semiconductor adj device and thermal adj sensor) and register	US-PGPUB	2003/01/04 1	
_	8	Semiconductor adj device and (thermal adj	USPAT;	2003/01/04 1	3:10
		sensor same register)	US-PGPUB		
-	450	324/760.ccls.	USPAT;	2003/01/04 1:	3:11
	1	702/122 2212	US-PGPUB	2003/01/04 1:	3 • 40
-	102	702/132.ccls.	USPAT; US-PGPUB	2003/01/04 1.	J.40
1	I		100 LGEOD	1	

		204/760 1	USPAT;	2003/01/04 13:11
- .	40	324/760.ccls. and register	US-PGPUB	2003/01/04 13.11
				2003/01/04 13:11
-	35	702/132.ccls. and register	USPAT;	2003/01/04 13:11
			US-PGPUB	2002/01/04 12:11
-	39		USPAT;	2003/01/04 13:11
		(702/132.ccls. and register)	US-PGPUB	
-	2	6091255.URPN.	USPAT	2003/01/04 13:34
_	3	1 1 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2 2	USPAT	2003/01/04 13:35
-	35	702/132.ccls. and register	USPAT;	2003/01/04 14:03
			US-PGPUB	
-	894	sensor near register	USPAT;	2003/01/04 14:04
			US-PGPUB	
-	23	(temperature thermal thermo) adj sensor	USPAT;	2003/01/04 14:04
		near register	US-PGPUB	<u> </u>
_	0	(thermal adj sensor) with (serial adj	USPAT;	2003/01/10 14:36
		interface)	US-PGPUB	İ
_	0	(thermal adj sensor) with (serial adj	USPAT;	2003/01/10 14:36
		interface)	US-PGPUB	
_	0	(thermal adj sensor) with (serial adj	EPO; JPO;	2003/01/10 14:36
		interface)	DERWENT;	1
			IBM_TDB	
-	1	(thermal adj sensor) same (serial adj	EPO; JPO;	2003/01/10 14:36
		interface)	DERWENT;	
		·	IBM TDB	
_	1	(thermal adj sensor) same (serial adj	USPAT;	2003/01/10 14:36
		interface)	US-PGPUB	
_	2	(thermal adj sensor) same (serial adj	USPAT;	2003/01/10 14:54
		interface)	US-PGPUB	
_	1 0	(temperature adj senspr) same (serial adj	USPAT;	2003/01/10 14:54
	1	interface)	US-PGPUB	
_	50	1	USPAT;	2003/01/10 14:56
		interface)	US-PGPUB	
_	13	1 =	USPAT;	2003/01/10 14:57
		interface)	US-PGPUB	
	L			